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### 1, Scope

The specifications should be applied to electret condenser microphone of DGO9465CD-L

### 2. Storage And Judgement Conditions

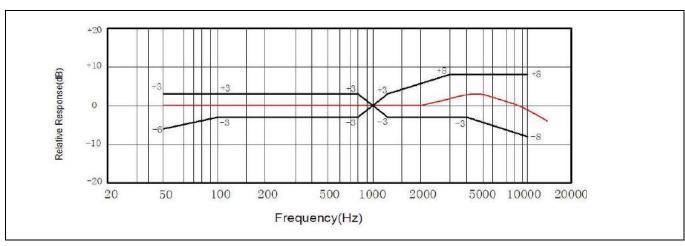
	Temperature Range(°C)	Rel. Humidity (%)	Static Pressure (kPa)
Judgement	19~21	60~70	86~106
Storage	-30~70		
Operating	-20~60		

# 3, Specifications

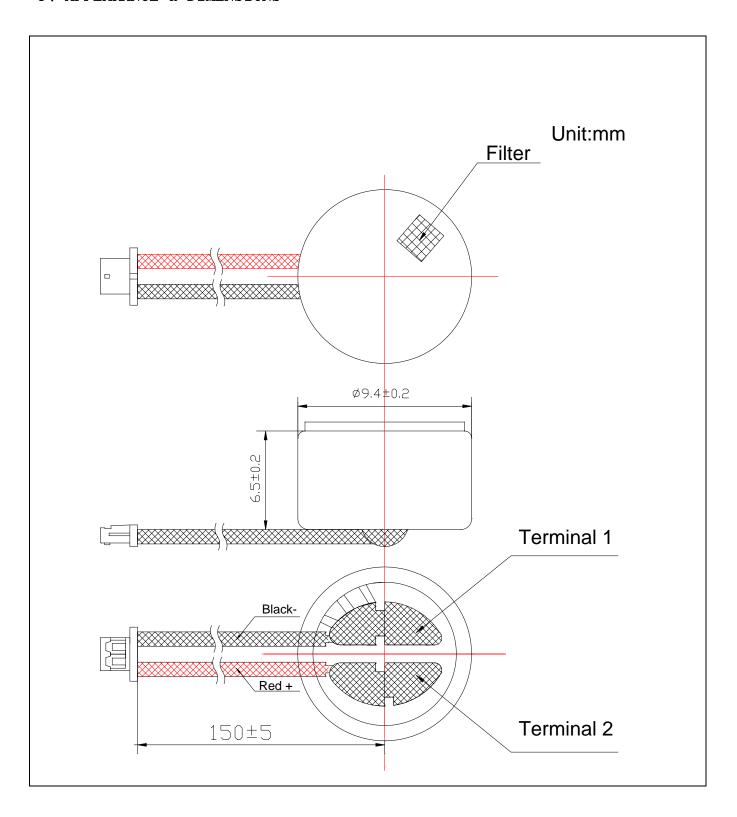
Test Conditions: Vs=2.0V, RL=2.2K  $\Omega$ , Temp=20 $\pm2^{\circ}$  C, R.H=60 $\pm5\%$ 

ITEM	Symbo1	Test Conditions	Min	Standard	Max	Unit
Sensitivity	S	f=1KHz,	-40	-38	-36	dB
		S. P. L=1 <b>P</b> a				0dB=1V/Pa
Impedance	Z	f=1KHz,			2.2	KΩ
		S. P. L=1 <b>P</b> a				
Directivity	Omni-directional					
Current Consumption	I				500	μΑ
Operation Voltage Range	Vs		1.0	4.5	10	V
S/N Ratio	S/N(A)	f=1KHz, S. P. L=1 <b>P</b> a	55			dB
		A Curve				
Decreacing Voltage Characteristic	ΔS	f=1KHz, S. P. L=1 <b>P</b> a			-3	dB
		Vs=2.0-1.5V				
Max. Input Sound Level	MISPL	f=1KHz,			110	dB
		Distortion≤3%				

# 4, Frequency Response



# 5、APPEARANCE & DIMENSIONS

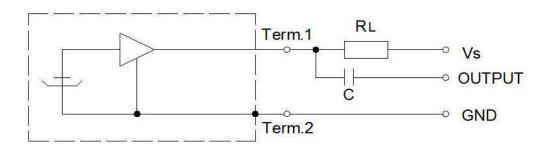


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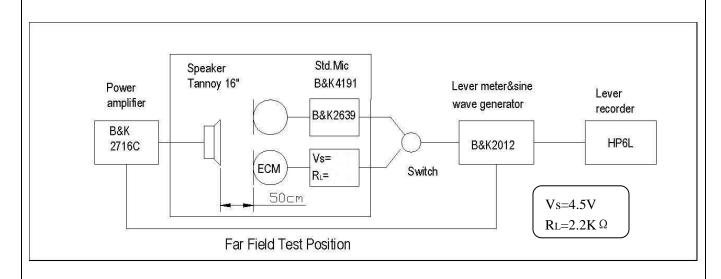
#### 6. Test Circuit

Measurement Circuit

Vs:Source Voltage 4.5V  $R_L$ :Load Resistance 2.2K $\Omega$ 



# 7. Test Setup Drawing



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### 8、 Reliability Test

All tests should be done after 2 hours of conditioning at  $20^{\circ}$ C, R. H65%, while the sensitivity is to be within  $\pm 3dB$  from the initial sensitivity after the following experiments.

# 8.1 High Temperature Test

High temperature:  $+60^{\circ}$ C

Duration: 72 hours

### 8.2 Low Temperature Test

Low temperature:  $-40^{\circ}$ C

Duration: 72 hours

# 8.3 Temperature Cycle Test (See in Fig.1)

Low temperature:  $-25^{\circ}$ C High temperature:  $+60^{\circ}$ C Changeover time: 10min Duration: 30min Cycle: 32

# 8.4 Statical Humidity Test

Temperature:  $+40^{\circ}\text{C}$  Relative humidity:  $90{\sim}95\%$  Duration: 72hours

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#### 8.5 Vibration Test

Amplitude: 1.52mm

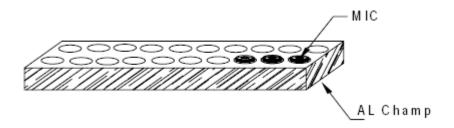
# 8.6 Dropping Test

Drop a unit unpacked onto a board of 20mm thick.

Height: 1.0 m Cycle: 6

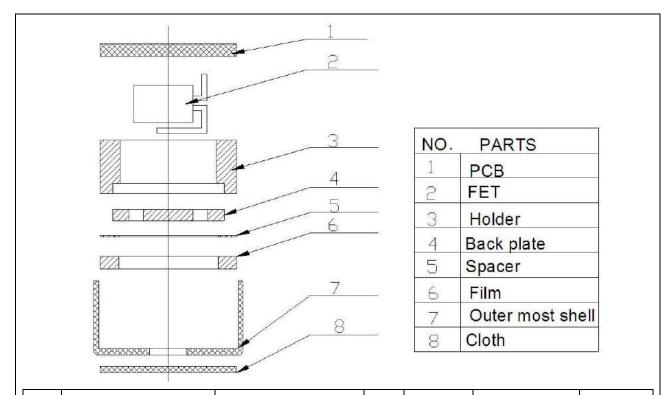
### 9. Regarding the Soldering operation

- a. Use 25~ 30W soldering iron and maintain  $310^{\circ}\text{C} \sim 330^{\circ}\text{C}$  in operation.
- b. Operators who work in the solder fixture and the soldering iron must be statically grounded under each soldering process.
- C. Soldering should be accomplished within two seconds at each terminal so as not to be overheated.
- d. Optimal design for heat sink pad is same as below.



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# 10. List and Structure of Materials



NO	Part name	Material Type	Qty	Origin	Manufacture	Remarks
1	РСВ	FR-1	1			
2	FET	K596	1			
3	Holder	ABS	1			
4	Back plate	Cu	1			
5	Spacer	Mylar	1			
6	Film	FEP	1			
7	Outer most shell	AL	1			
8	Cloth	Fabrics	1			

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#### 11 HANDLING INSTRUCTION

- 1. Assembly process
  - a). After connector and holder are once disassembled, they should not be re-used.
- b). Do not touch outer springs directly(except for PCB or proper terminal set at nominal height.
  - c). Do not give any mechanical shocks to the micphone(e.g. dropping to floor)
- 2. General information
  - 2-1: This microphone shall not be operated or stored in following environment.
    - >where liquid(water, solvent and so on) splashes.
    - >where the air has a high concentration of corrosive gas .
    - >where is too dusty.
    - >where temperature changes rapidly.
- 2-2: Frequency response especially in high frequency region is dependent on the structure of enclosure.

Please remove additional acoustic mass or cavity in front of the microphone to the utmost.

- 2-3:do not put mechanical pressure more than 2 kg to the microphone.
- 2-4: microphone should not be in state of outgoing packing for a long-term storage.
- 2-5: all the soldering procedures upon microphone must be complete in a metallic device, the temperature of the soldering irons must be limited as 320°C and less 3 s , the operators, the solder fixtures and the soldering irons must be statically grounded under each soldering process.